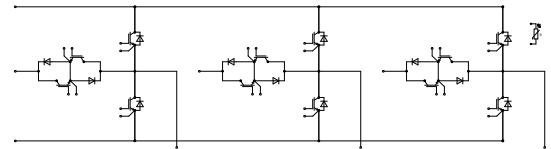
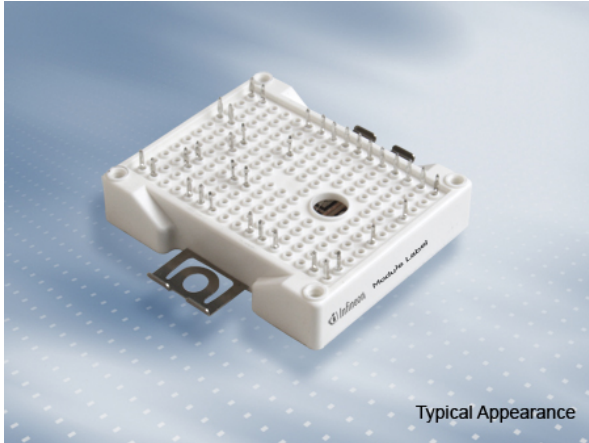


**Vorläufige Daten / Preliminary Data**



$V_{CES} = 1200V$   
 $I_{C\ nom} = 15A / I_{CRM} = 30A$

**Typische Anwendungen**

- 3-Level-Applikationen
- Solar Anwendungen

**Elektrische Eigenschaften**

- Niederinduktives Design
- Niedrige Schaltverluste
- Niedriges  $V_{CEsat}$

**Mechanische Eigenschaften**

- $Al_2O_3$  Substrat mit kleinem thermischen Widerstand
- Kompaktes Design
- PressFIT Verbindungstechnik
- Robuste Montage durch integrierte Befestigungsklammern

**Typical Applications**

- 3-Level-Applications
- Solar Applications

**Electrical Features**

- Low inductive design
- Low Switching Losses
- Low  $V_{CEsat}$

**Mechanical Features**

- $Al_2O_3$  Substrate with Low Thermal Resistance
- Compact design
- PressFIT Contact Technology
- Rugged mounting due to integrated mounting clamps

**Module Label Code**

Barcode Code 128



DMX - Code



**Content of the Code**

| Content of the Code        | Digit   |
|----------------------------|---------|
| Module Serial Number       | 1 - 5   |
| Module Material Number     | 6 - 11  |
| Production Order Number    | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

|                 |                                 |                      |
|-----------------|---------------------------------|----------------------|
| prepared by: CM | date of publication: 2013-11-25 |                      |
| approved by: MB | revision: 2.0                   | UL approved (E83335) |



**Vorläufige Daten  
Preliminary Data**

**IGBT, Wechselrichter / IGBT, Inverter  
Höchstzulässige Werte / Maximum Rated Values**

|  |   |                            |          |        |
|--|---|----------------------------|----------|--------|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$   | $V_{CES}$                  | 1200     | V      |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_C = 100^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$<br>$T_C = 25^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$ | $I_{C\text{nom}}$<br>$I_C$ | 15<br>20 | A<br>A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\text{ ms}$   | $I_{CRM}$                  | 30       | A      |
| Gesamt-Verlustleistung<br>Total power dissipation                        | $T_C = 25^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$  | $P_{\text{tot}}$           | 145      | W      |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |   | $V_{GES}$                  | +/-20    | V      |

**Charakteristische Werte / Characteristic Values**

|   |   |   | min.               | typ.                    | max. |   |
|---|---|---|--------------------|-------------------------|------|---|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage    | $I_C = 15\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 15\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 15\text{ A}, V_{GE} = 15\text{ V}$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_{CE\text{sat}}$ | 2,05<br>2,50<br>2,60    | 2,40 | V<br>V<br>V                                     |
| Gate-Schwellenspannung<br>Gate threshold voltage                                | $I_C = 0,50\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$  |   | $V_{GEth}$         | 5,0<br>5,8<br>6,5       |      | V   |
| Gateladung<br>Gate charge   | $V_{GE} = -15\text{ V} \dots +15\text{ V}$  |   | $Q_G$              | 0,075                   |      | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                               | $T_{vj} = 25^{\circ}\text{C}$   |   | $R_{Gint}$         | 0,0                     |      | $\Omega$  |
| Eingangskapazität<br>Input capacitance  | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$  |   | $C_{ies}$          | 0,875                   |      | nF  |
| Rückwirkungskapazität<br>Reverse transfer capacitance                           | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$  |   | $C_{res}$          | 0,045                   |      | nF  |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                | $V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$  |   | $I_{CES}$          |                         | 1,0  | mA  |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                          | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$  |   | $I_{GES}$          |                         | 100  | nA  |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{Gon} = 35\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{don}$          | 0,04<br>0,04<br>0,04    |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                       | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{Gon} = 35\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_r$              | 0,025<br>0,026<br>0,027 |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{Goff} = 35\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{doff}$         | 0,27<br>0,31<br>0,32    |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                           | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{Goff} = 35\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_f$              | 0,02<br>0,03<br>0,035   |      | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse               | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}, L_S = 30\text{ nH}$<br>$V_{GE} = 15\text{ V}, di/dt = 700\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{Gon} = 35\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{on}$           | 0,40<br>0,60<br>0,64    |      | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse               | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}, L_S = 30\text{ nH}$<br>$V_{GE} = 15\text{ V}, du/dt = 2800\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{Goff} = 35\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{off}$          | 0,37<br>0,53<br>0,54    |      | mJ<br>mJ<br>mJ                                  |
| Kurzschlussverhalten<br>SC data   | $V_{GE} \leq 15\text{ V}, V_{CC} = 800\text{ V}$<br>$V_{CE\text{max}} = V_{CES} - L_{SCE} \cdot di/dt$ $t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$                       |   | $I_{SC}$           | 48                      |      | A   |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro IGBT / per IGBT   |   | $R_{thJC}$         | 0,95                    | 1,05 | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro IGBT / per IGBT<br>$\lambda_{\text{Paste}} = 1\text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{\text{grease}} = 1\text{ W}/(\text{m}\cdot\text{K})$                                 |   | $R_{thCH}$         | 0,80                    |      | K/W   |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |   |   | $T_{vj\text{op}}$  | -40                     | 150  | $^{\circ}\text{C}$                              |

|                 |                                 |
|-----------------|---------------------------------|
| prepared by: CM | date of publication: 2013-11-25 |
| approved by: MB | revision: 2.0                   |



**Vorläufige Daten  
Preliminary Data**

**Diode, Wechselrichter / Diode, Inverter  
Höchstzulässige Werte / Maximum Rated Values**

|   |  |           |              |                                      |
|---|--|-----------|--------------|--------------------------------------|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$  | $V_{RRM}$ | 1200         | V                                    |
| Dauergleichstrom<br>Continuous DC forward current                   |  | $I_F$     | 15           | A                                    |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_P = 1\text{ ms}$  | $I_{FRM}$ | 50           | A                                    |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 40,0<br>34,0 | A <sup>2</sup> s<br>A <sup>2</sup> s |

**Charakteristische Werte / Characteristic Values**

|   |   |   | min.               | typ.                 | max. |   |
|---|---|---|--------------------|----------------------|------|---|
| Durchlassspannung<br>Forward voltage  | $I_F = 15\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 15\text{ A}, V_{GE} = 0\text{ V}$<br>$I_F = 15\text{ A}, V_{GE} = 0\text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$              | 1,75<br>1,75<br>1,75 | 2,15 | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                | $I_F = 15\text{ A}, -di_F/dt = 1300\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 350\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$           | 36,0<br>38,0<br>38,0 |      | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                     | $I_F = 15\text{ A}, -di_F/dt = 1300\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 350\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$              | 1,05<br>2,10<br>2,40 |      | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                             | $I_F = 15\text{ A}, -di_F/dt = 1300\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 350\text{ V}$<br>$V_{GE} = -15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$          | 0,40<br>0,66<br>0,70 |      | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode   |   | $R_{thJC}$         | 1,30                 | 1,45 | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{Paste} = 1\text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$ |   | $R_{thCH}$         | 1,05                 |      | K/W   |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |   |   | $T_{vj\text{ op}}$ | -40                  | 150  | $^{\circ}\text{C}$                              |

|                 |                                 |
|-----------------|---------------------------------|
| prepared by: CM | date of publication: 2013-11-25 |
| approved by: MB | revision: 2.0                   |



**Vorläufige Daten  
Preliminary Data**

**IGBT,3-Level / IGBT,3-Level**

**Höchstzulässige Werte / Maximum Rated Values**

|  |   |                            |          |        |
|--|---|----------------------------|----------|--------|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$   | $V_{CES}$                  | 650      | V      |
| Implementierter Kollektor-Strom<br>Implemented collector current         |   | $I_{CN}$                   | 30       | A      |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_C = 100^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$<br>$T_C = 25^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$ | $I_{C\text{nom}}$<br>$I_C$ | 15<br>25 | A<br>A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_P = 1\text{ ms}$   | $I_{CRM}$                  | 60       | A      |
| Gesamt-Verlustleistung<br>Total power dissipation                        | $T_C = 25^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$  | $P_{\text{tot}}$           | 150      | W      |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |   | $V_{GES}$                  | +/-20    | V      |

**Charakteristische Werte / Characteristic Values**

|   |  |   | min.               | typ.                    | max. |             |   |
|---|--|---|--------------------|-------------------------|------|-------------|---|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage    | $I_C = 15\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 15\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 15\text{ A}, V_{GE} = 15\text{ V}$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $V_{CE\text{sat}}$ | 1,20<br>1,25<br>1,25    | 1,45 | V<br>V<br>V |   |
| Gate-Schwellenspannung<br>Gate threshold voltage                                | $I_C = 0,30\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$   |   | $V_{G\text{Eth}}$  | 4,9                     | 5,8  | 6,5         | V   |
| Gateladung<br>Gate charge   | $V_{GE} = -15\text{ V} \dots +15\text{ V}$   |   | $Q_G$              | 0,30                    |      |             | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                               | $T_{vj} = 25^{\circ}\text{C}$  |   | $R_{G\text{int}}$  | 0,0                     |      |             | $\Omega$  |
| Eingangskapazität<br>Input capacitance  | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$   |   | $C_{\text{ies}}$   | 1,65                    |      |             | nF  |
| Rückwirkungskapazität<br>Reverse transfer capacitance                           | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$   |   | $C_{\text{res}}$   | 0,051                   |      |             | nF  |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                | $V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$  |   | $I_{CES}$          |                         |      | 1,0         | mA  |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                          | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$   |   | $I_{GES}$          |                         |      | 100         | nA  |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{G\text{on}} = 15\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_{d\text{on}}$   | 0,035<br>0,035<br>0,035 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                       | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{G\text{on}} = 15\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_r$              | 0,01<br>0,012<br>0,013  |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{G\text{off}} = 15\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_{d\text{off}}$  | 0,34<br>0,38<br>0,39    |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                           | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}$<br>$V_{GE} = 15\text{ V}$<br>$R_{G\text{off}} = 15\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $t_f$              | 0,045<br>0,07<br>0,075  |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse               | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}, L_S = 40\text{ nH}$<br>$V_{GE} = 15\text{ V}, di/dt = 1300\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{G\text{on}} = 15\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $E_{\text{on}}$    | 0,19<br>0,26<br>0,28    |      |             | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse               | $I_C = 15\text{ A}, V_{CE} = 350\text{ V}, L_S = 40\text{ nH}$<br>$V_{GE} = 15\text{ V}, du/dt = 2600\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$<br>$R_{G\text{off}} = 15\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                 | $E_{\text{off}}$   | 0,47<br>0,60<br>0,64    |      |             | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data  | $V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}$<br>$V_{CE\text{max}} = V_{CES} - L_{SCE} \cdot di/dt$   | $t_P \leq 8\ \mu\text{s}, T_{vj} = 25^{\circ}\text{C}$<br>$t_P \leq 6\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ | $I_{SC}$           | 210<br>150              |      |             | A<br>A  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro IGBT / per IGBT  |   | $R_{\text{thJC}}$  | 0,90                    | 1,00 |             | K/W   |

|                 |                                 |
|-----------------|---------------------------------|
| prepared by: CM | date of publication: 2013-11-25 |
| approved by: MB | revision: 2.0                   |



**Vorläufige Daten  
Preliminary Data**

|   |   |                    |     |      |     |     |
|---|---|--------------------|-----|------|-----|-----|
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro IGBT / per IGBT<br>$\lambda_{\text{Paste}} = 1 \text{ W/(m}\cdot\text{K)}$ / $\lambda_{\text{grease}} = 1 \text{ W/(m}\cdot\text{K)}$ | $R_{\text{thCH}}$  |     | 0,85 |     | K/W |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |   | $T_{\text{vj op}}$ | -40 |      | 150 | °C  |

**Diode, 3-Level / Diode, 3-Level**

**Höchstzulässige Werte / Maximum Rated Values**

|   |  |                  |  |              |  |  |
|---|--|------------------|--|--------------|--|--|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{\text{vj}} = 25^\circ\text{C}$   | $V_{\text{RRM}}$ |  | 650          |  | V  |
| Dauergleichstrom<br>Continuous DC forward current                   |  | $I_{\text{F}}$   |  | 15           |  | A  |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_{\text{p}} = 1 \text{ ms}$  | $I_{\text{FRM}}$ |  | 30           |  | A  |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_{\text{R}} = 0 \text{ V}, t_{\text{p}} = 10 \text{ ms}, T_{\text{vj}} = 125^\circ\text{C}$<br>$V_{\text{R}} = 0 \text{ V}, t_{\text{p}} = 10 \text{ ms}, T_{\text{vj}} = 150^\circ\text{C}$ | $I^2t$           |  | 32,0<br>28,0 |  | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|   |  |  |                    | min. | typ.                 | max.   |   |
|---|--|--|--------------------|------|----------------------|--------|---|
| Durchlassspannung<br>Forward voltage  | $I_{\text{F}} = 15 \text{ A}, V_{\text{GE}} = 0 \text{ V}$<br>$I_{\text{F}} = 15 \text{ A}, V_{\text{GE}} = 0 \text{ V}$<br>$I_{\text{F}} = 15 \text{ A}, V_{\text{GE}} = 0 \text{ V}$ | $T_{\text{vj}} = 25^\circ\text{C}$<br>$T_{\text{vj}} = 125^\circ\text{C}$<br>$T_{\text{vj}} = 150^\circ\text{C}$ | $V_{\text{F}}$     |      | 1,45<br>1,35<br>1,30 | t.b.d. | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                | $I_{\text{F}} = 15 \text{ A}, -di_{\text{F}}/dt = 700 \text{ A}/\mu\text{s} (T_{\text{vj}}=150^\circ\text{C})$<br>$V_{\text{R}} = 350 \text{ V}$                                       | $T_{\text{vj}} = 25^\circ\text{C}$<br>$T_{\text{vj}} = 125^\circ\text{C}$<br>$T_{\text{vj}} = 150^\circ\text{C}$ | $I_{\text{RM}}$    |      | 13,0<br>15,0<br>16,0 |        | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                     | $I_{\text{F}} = 15 \text{ A}, -di_{\text{F}}/dt = 700 \text{ A}/\mu\text{s} (T_{\text{vj}}=150^\circ\text{C})$<br>$V_{\text{R}} = 350 \text{ V}$                                       | $T_{\text{vj}} = 25^\circ\text{C}$<br>$T_{\text{vj}} = 125^\circ\text{C}$<br>$T_{\text{vj}} = 150^\circ\text{C}$ | $Q_{\text{r}}$     |      | 0,60<br>1,00<br>1,15 |        | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                             | $I_{\text{F}} = 15 \text{ A}, -di_{\text{F}}/dt = 700 \text{ A}/\mu\text{s} (T_{\text{vj}}=150^\circ\text{C})$<br>$V_{\text{R}} = 350 \text{ V}$                                       | $T_{\text{vj}} = 25^\circ\text{C}$<br>$T_{\text{vj}} = 125^\circ\text{C}$<br>$T_{\text{vj}} = 150^\circ\text{C}$ | $E_{\text{rec}}$   |      | 0,12<br>0,18<br>0,22 |        | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode  |  | $R_{\text{thJC}}$  |      | 1,95                 | 2,15   | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{\text{Paste}} = 1 \text{ W/(m}\cdot\text{K)}$ / $\lambda_{\text{grease}} = 1 \text{ W/(m}\cdot\text{K)}$  |  | $R_{\text{thCH}}$  |      | 1,35                 |        | K/W   |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions           |  |  | $T_{\text{vj op}}$ | -40  |                      | 150    | °C  |

**NTC-Widerstand / NTC-Thermistor**

**Charakteristische Werte / Characteristic Values**

|  |  |  |              | min. | typ. | max. |            |
|--|--|--|--------------|------|------|------|------------|
| Nennwiderstand<br>Rated resistance       | $T_{\text{C}} = 25^\circ\text{C}$                              |  | $R_{25}$     |      | 5,00 |      | k $\Omega$ |
| Abweichung von R100<br>Deviation of R100 | $T_{\text{C}} = 100^\circ\text{C}, R_{100} = 493 \Omega$       |  | $\Delta R/R$ | -5   |      | 5    | %          |
| Verlustleistung<br>Power dissipation     | $T_{\text{C}} = 25^\circ\text{C}$                              |  | $P_{25}$     |      |      | 20,0 | mW         |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  |  | $B_{25/50}$  |      | 3375 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  |  | $B_{25/80}$  |      | 3411 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ |  | $B_{25/100}$ |      | 3433 |      | K          |

Angaben gemäß gültiger Application Note.  
Specification according to the valid application note.

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**Vorläufige Daten  
Preliminary Data**

**Modul / Module**

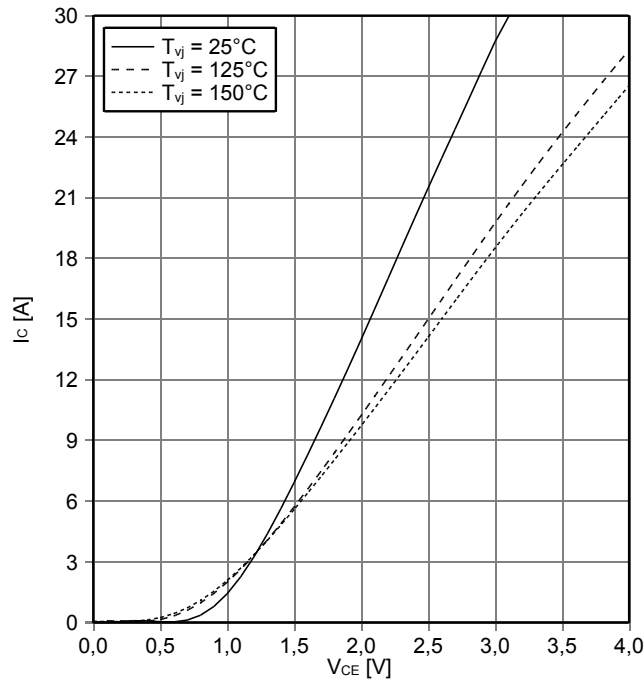
|   |   |                   |                                |      |      |    |
|---|---|-------------------|--------------------------------|------|------|----|
| Isolations-Prüfspannung<br>Isolation test voltage                 | RMS, f = 50 Hz, t = 1 min.  | V <sub>ISOL</sub> | 2,5                            |      |      | kV |
| Innere Isolation<br>Internal isolation                            | Basisisolierung (Schutzklasse 1, EN61140)<br>basic insulation (class 1, IEC 61140)      |                   | Al <sub>2</sub> O <sub>3</sub> |      |      |    |
| Kriechstrecke<br>Creepage distance                                | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal |                   | 13,5<br>7,5                    |      |      | mm |
| Luftstrecke<br>Clearance  | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal |                   | 12,0<br>7,5                    |      |      | mm |
| Vergleichszahl der Kriechwegbildung<br>Comperative tracking index |   | CTI               | > 200                          |      |      |    |
|   |   |                   | min.                           | typ. | max. |    |
| Modulstreuinduktivität<br>Stray inductance module                 |   | L <sub>sCE</sub>  |                                | 25   |      | nH |
| Lagertemperatur<br>Storage temperature                            |   | T <sub>stg</sub>  | -40                            |      | 125  | °C |
| Anpresskraft für mech. Bef. pro Feder<br>mounting force per clamp |   | F                 | 40                             | -    | 80   | N  |
| Gewicht<br>Weight   |   | G                 |                                | 36   |      | g  |

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**Vorläufige Daten**  
**Preliminary Data**

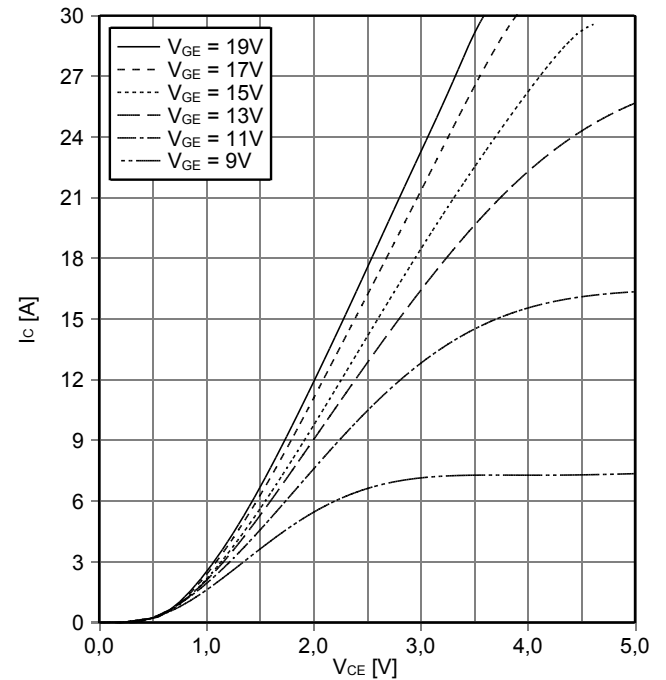
**Ausgangskennlinie IGBT, Wechselrichter (typisch)**  
**output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



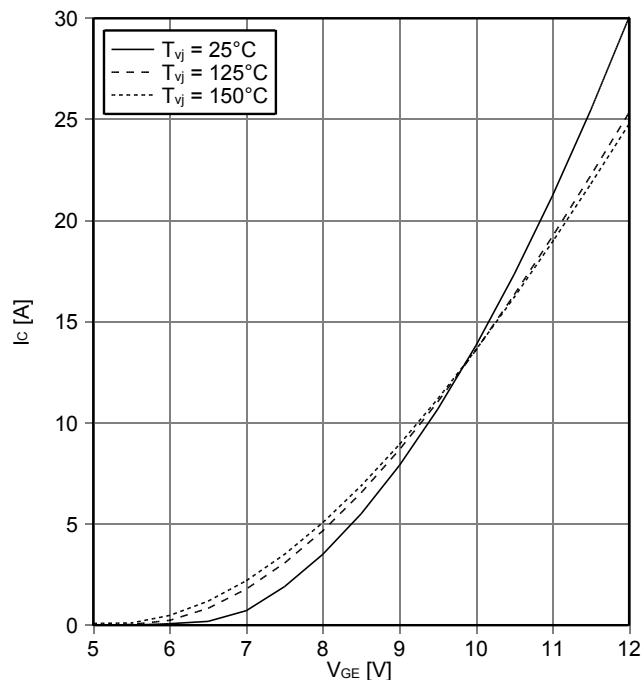
**Ausgangskennlinienfeld IGBT, Wechselrichter (typisch)**  
**output characteristic IGBT, Inverter (typical)**

$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



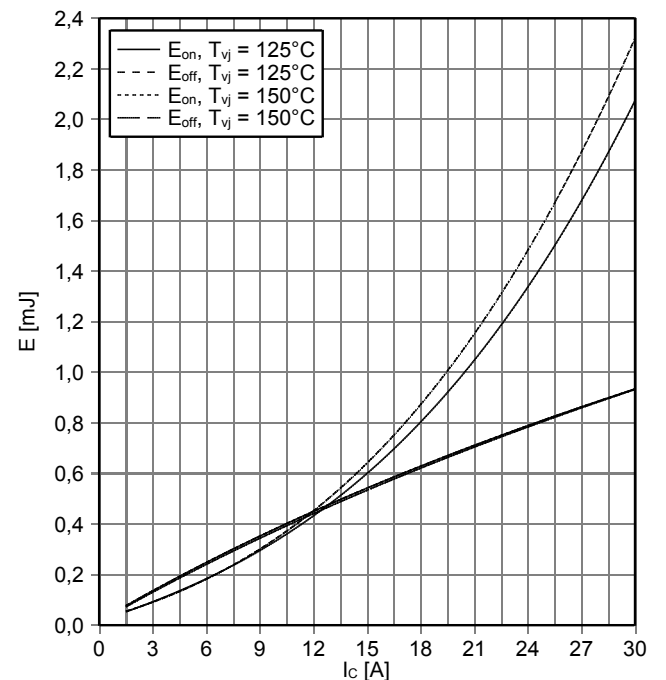
**Übertragungscharakteristik IGBT, Wechselrichter (typisch)**  
**transfer characteristic IGBT, Inverter (typical)**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



**Schaltverluste IGBT, Wechselrichter (typisch)**  
**switching losses IGBT, Inverter (typical)**

$E_{on} = f(I_C), E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}, R_{Gon} = 35\ \Omega, R_{Goff} = 35\ \Omega, V_{CE} = 350\text{ V}$



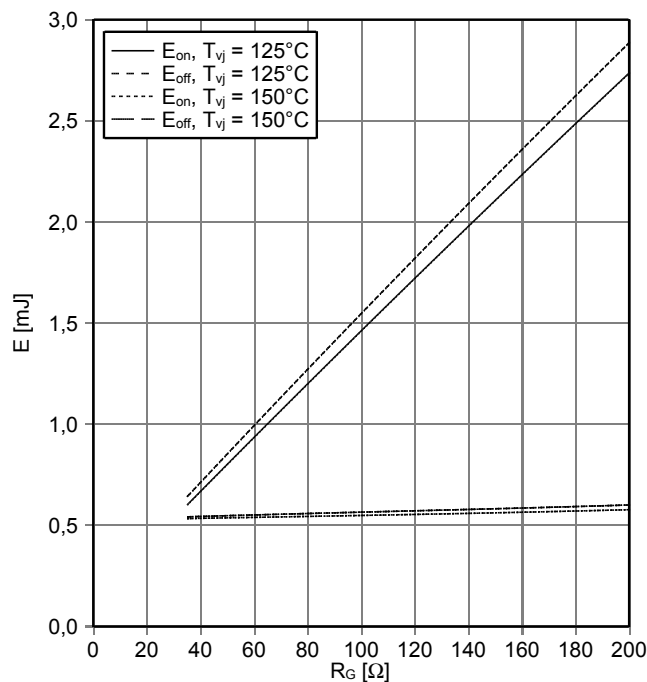
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**Vorläufige Daten  
Preliminary Data**

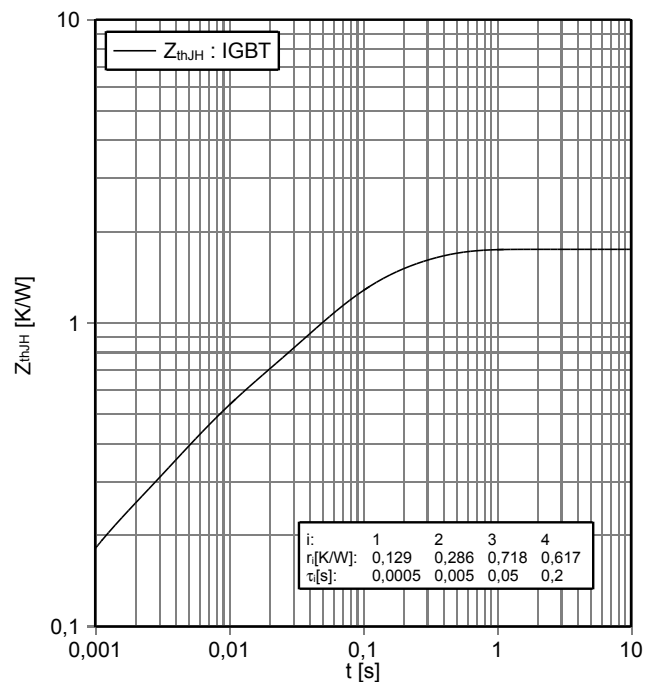
**Schaltverluste IGBT, Wechselrichter (typisch)  
switching losses IGBT, Inverter (typical)**

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 15\text{ A}$ ,  $V_{CE} = 350\text{ V}$



**Transienter Wärmewiderstand IGBT, Wechselrichter  
transient thermal impedance IGBT, Inverter**

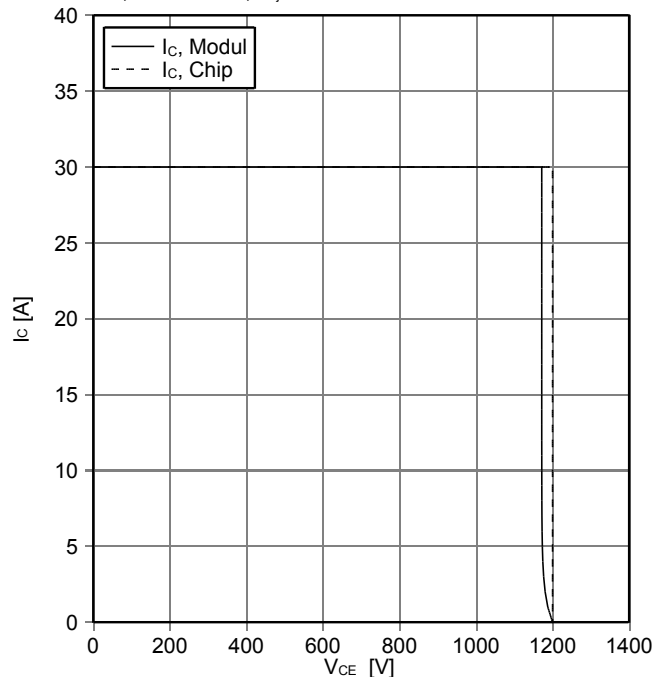
$Z_{thJH} = f(t)$



**Sicherer Rückwärts-Arbeitsbereich IGBT, Wechselrichter  
(RBSOA)**

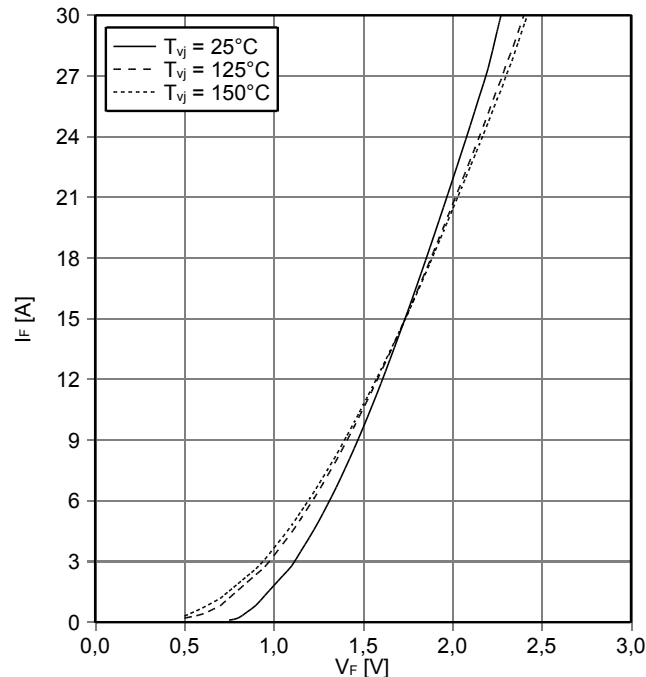
**reverse bias safe operating area IGBT, Inverter (RBSOA)**

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Goff} = 35\ \Omega$ ,  $T_{vj} = 150^\circ\text{C}$



**Durchlasskennlinie der Diode, Wechselrichter (typisch)  
forward characteristic of Diode, Inverter (typical)**

$I_F = f(V_F)$



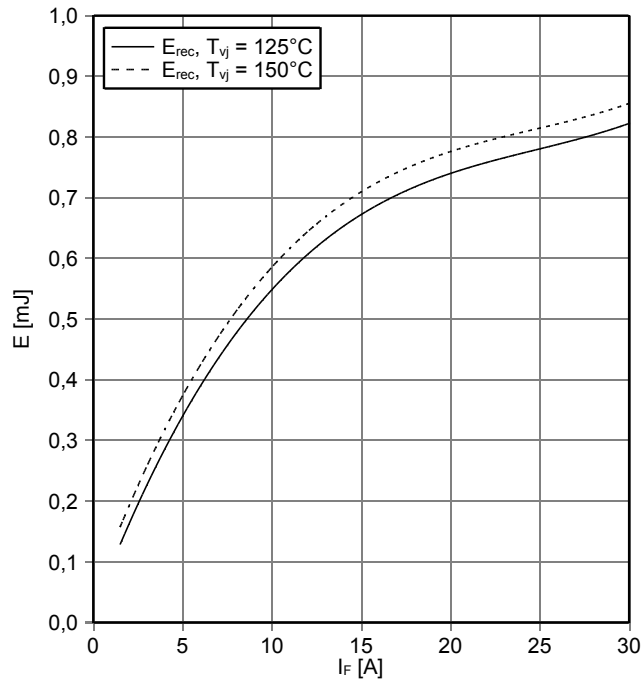
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| prepared by: CM | date of publication: 2013-11-25 |
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**Vorläufige Daten**  
**Preliminary Data**

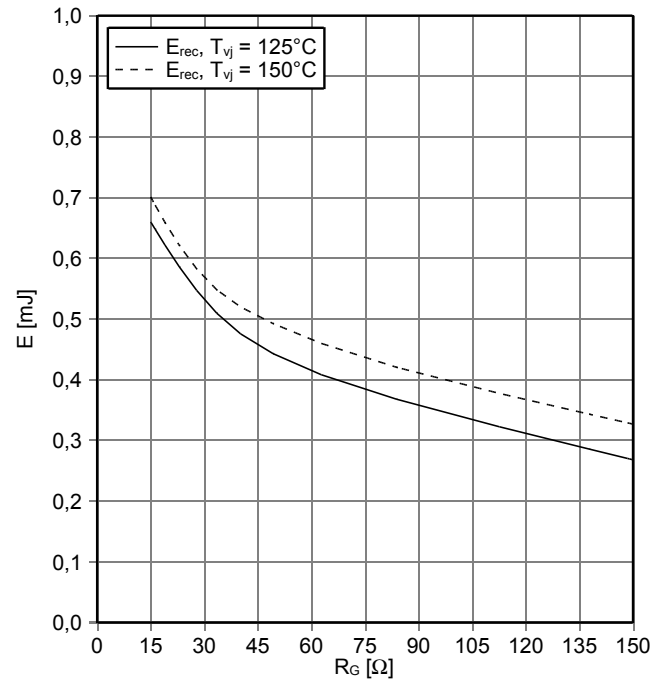
**Schaltverluste Diode, Wechselrichter (typisch)**  
**switching losses Diode, Inverter (typical)**

$E_{rec} = f(I_F)$   
 $R_{Gon} = 15 \Omega, V_{CE} = 350 V$



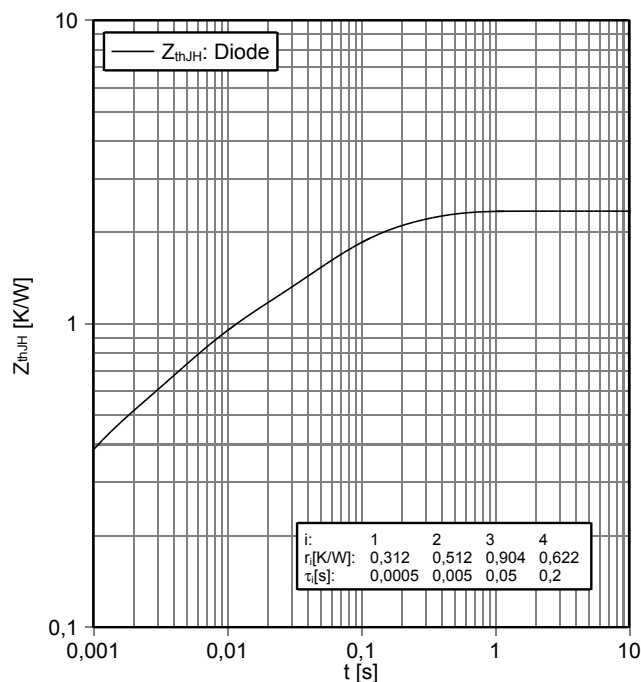
**Schaltverluste Diode, Wechselrichter (typisch)**  
**switching losses Diode, Inverter (typical)**

$E_{rec} = f(R_G)$   
 $I_F = 15 A, V_{CE} = 350 V$



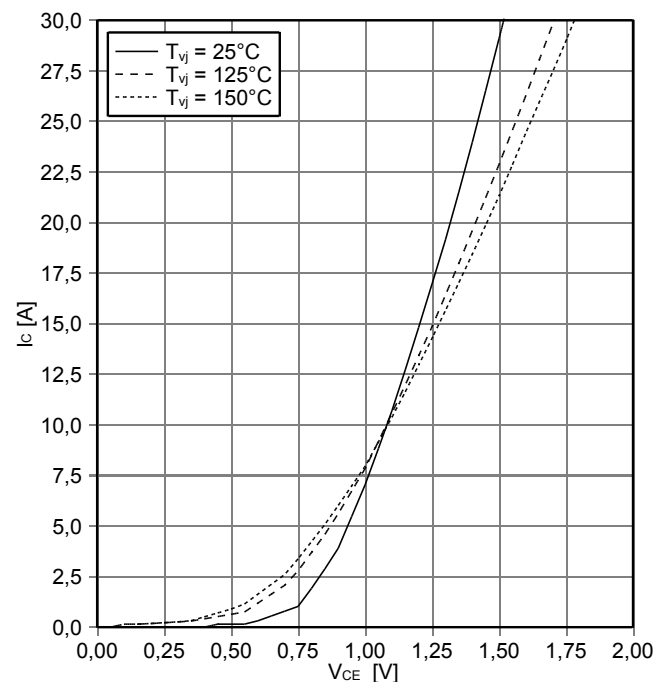
**Transienter Wärmewiderstand Diode, Wechselrichter**  
**transient thermal impedance Diode, Inverter**

$Z_{thJH} = f(t)$



**Ausgangskennlinie IGBT,3-Level (typisch)**  
**output characteristic IGBT,3-Level (typical)**

$I_C = f(V_{CE})$   
 $V_{GE} = 15 V$

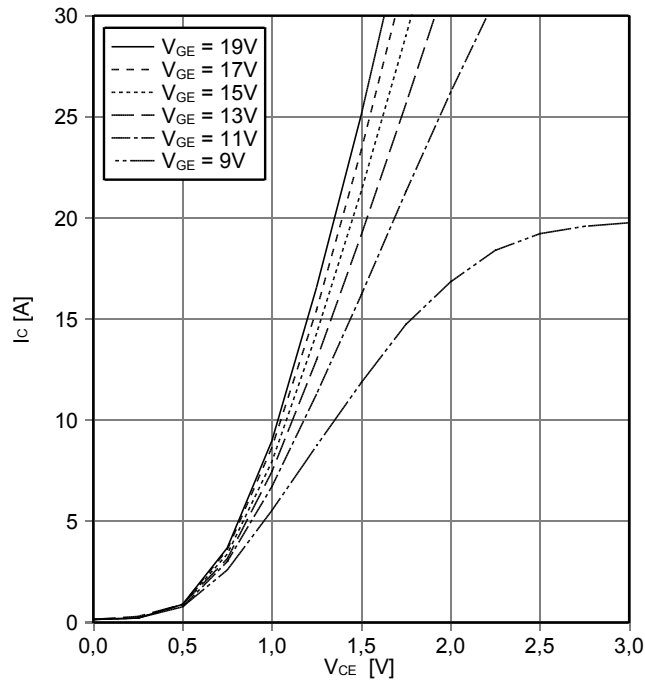


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**Vorläufige Daten**  
**Preliminary Data**

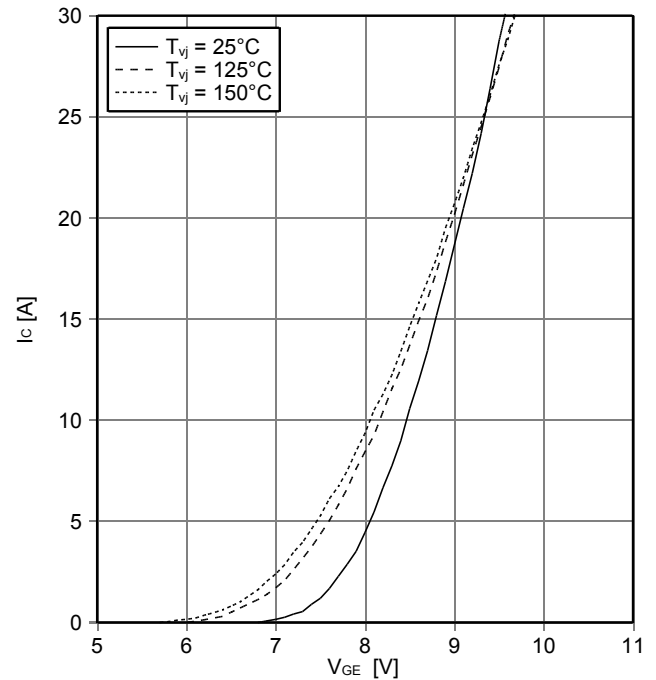
**Ausgangskennlinienfeld IGBT,3-Level (typisch)**  
**output characteristic IGBT,3-Level (typical)**

$I_c = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



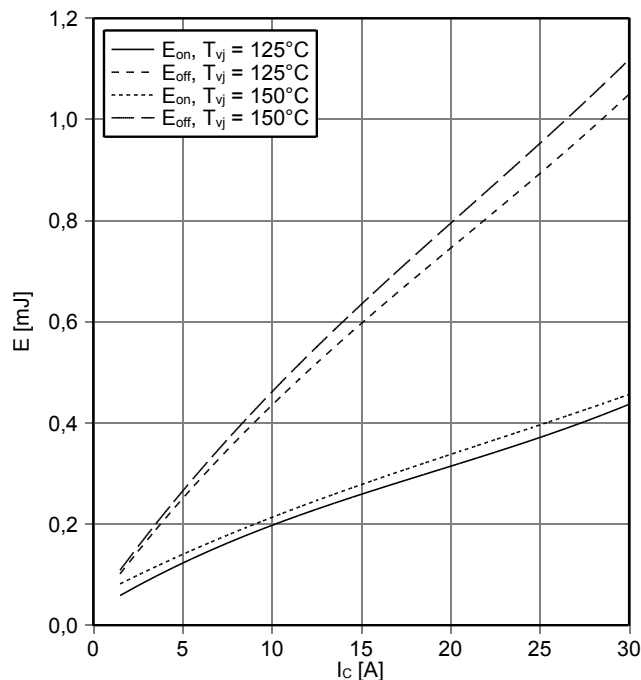
**Übertragungscharakteristik IGBT,3-Level (typisch)**  
**transfer characteristic IGBT,3-Level (typical)**

$I_c = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



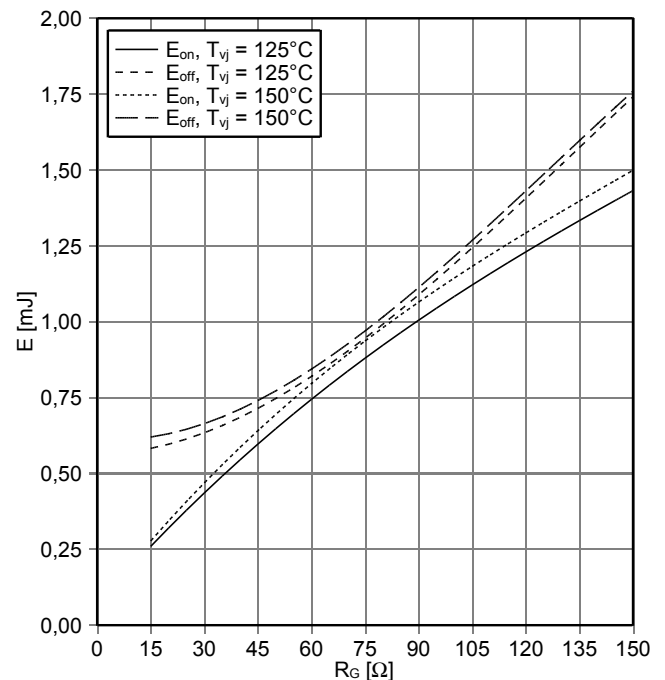
**Schaltverluste IGBT,3-Level (typisch)**  
**switching losses IGBT,3-Level (typical)**

$E_{on} = f(I_c), E_{off} = f(I_c)$   
 $V_{GE} = \pm 15\text{ V}, R_{Gon} = 15\ \Omega, R_{Goff} = 15\ \Omega, V_{CE} = 350\text{ V}$



**Schaltverluste IGBT,3-Level (typisch)**  
**switching losses IGBT,3-Level (typical)**

$E_{on} = f(R_G), E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}, I_c = 15\text{ A}, V_{CE} = 350\text{ V}$



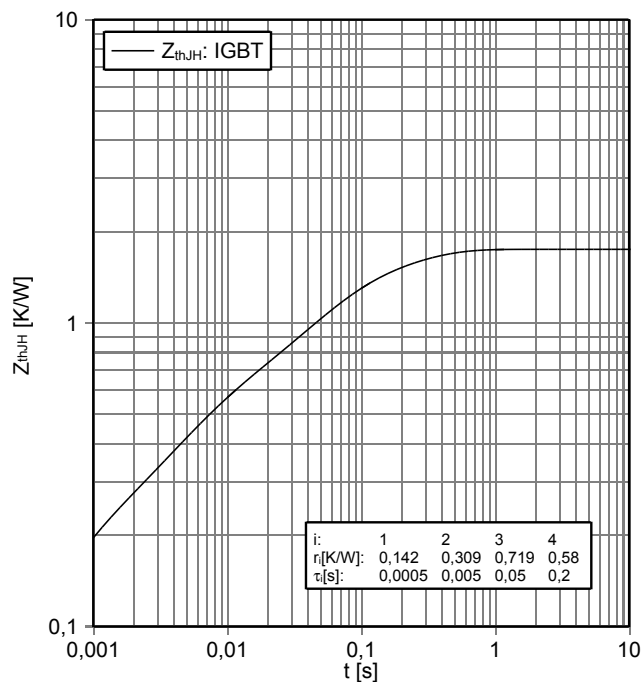
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**Vorläufige Daten**  
**Preliminary Data**

**Transienter Wärmewiderstand IGBT,3-Level**  
**transient thermal impedance IGBT,3-Level**

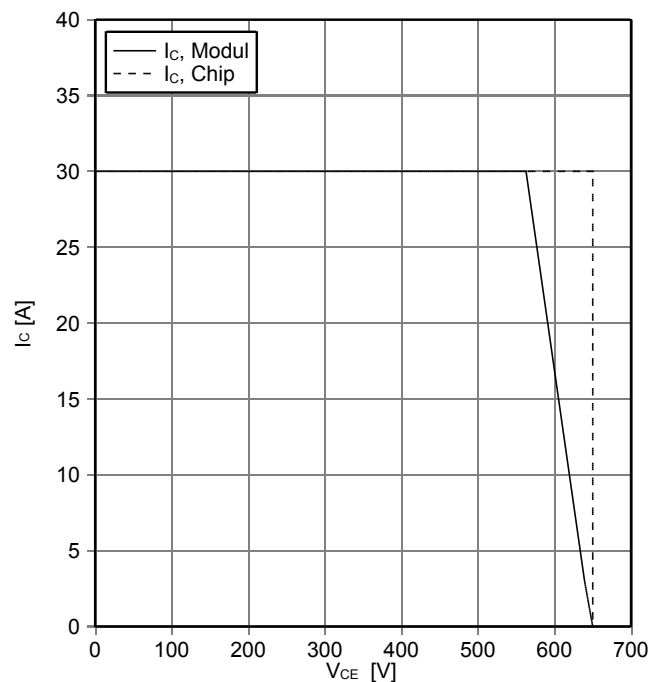
$Z_{thJH} = f(t)$



**Sicherer Rückwärts-Arbeitsbereich IGBT,3-Level (RBSOA)**  
**reverse bias safe operating area IGBT,3-Level (RBSOA)**

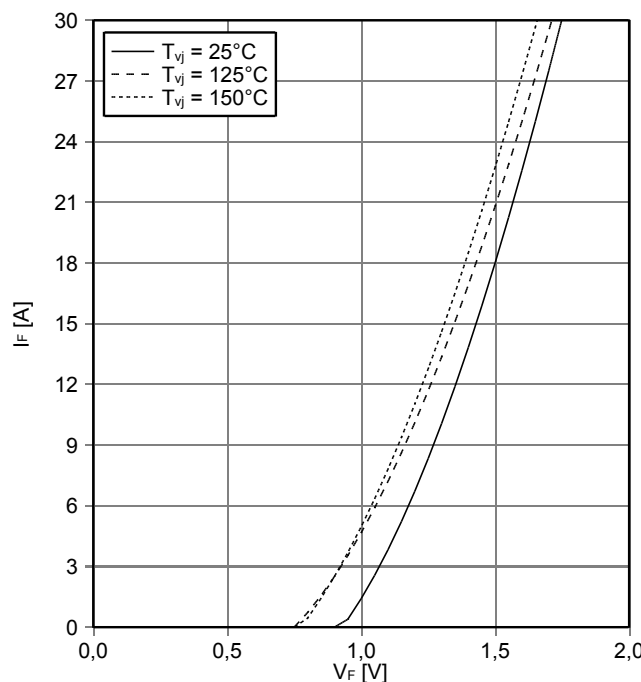
$I_C = f(V_{CE})$

$V_{GE} = \pm 15 \text{ V}, R_{Goff} = 15 \Omega, T_{vj} = 150^\circ\text{C}$



**Durchlasskennlinie der Diode, 3-Level (typisch)**  
**forward characteristic of Diode, 3-Level (typical)**

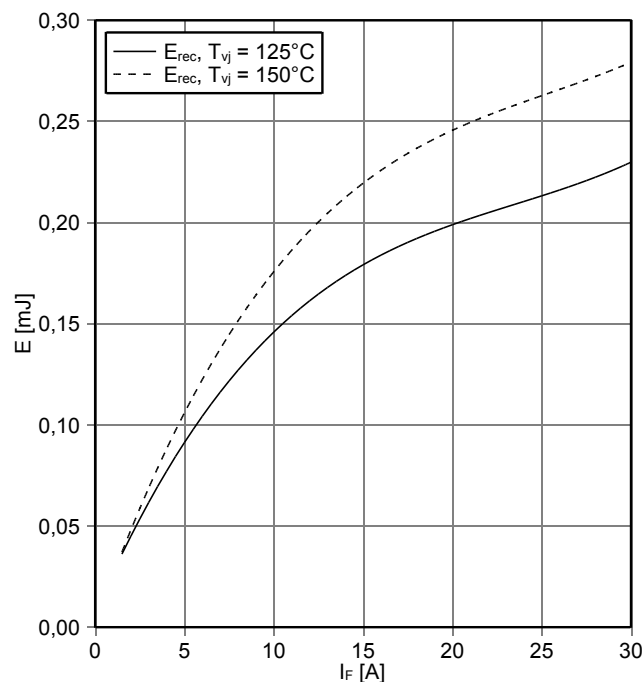
$I_F = f(V_F)$



**Schaltverluste Diode, 3-Level (typisch)**  
**switching losses Diode, 3-Level (typical)**

$E_{rec} = f(I_F)$

$R_{Gon} = 35 \Omega, V_{CE} = 350 \text{ V}$

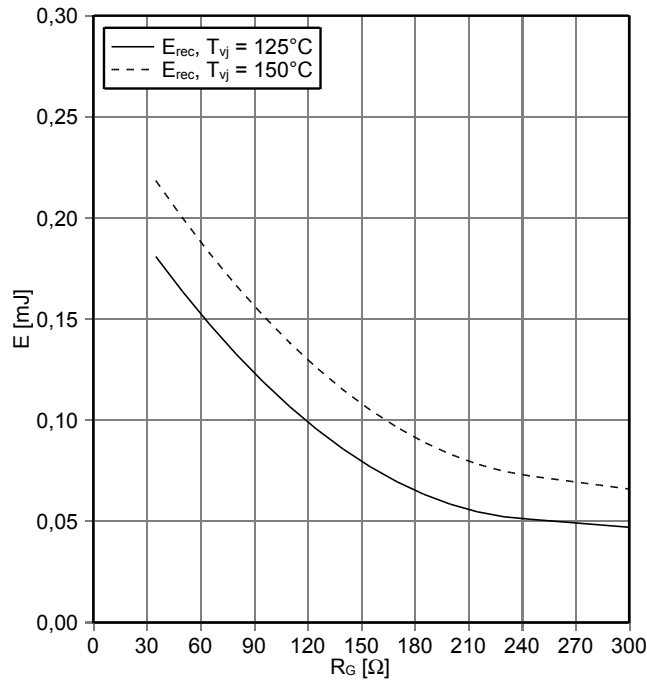


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**Vorläufige Daten  
Preliminary Data**

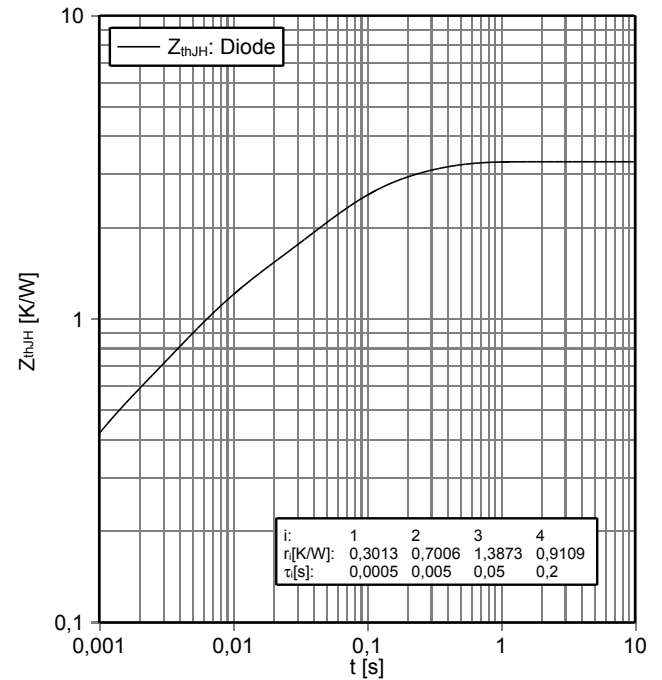
**Schaltverluste Diode, 3-Level (typisch)  
switching losses Diode, 3-Level (typical)**

$E_{rec} = f(R_G)$   
 $I_F = 15\text{ A}, V_{CE} = 350\text{ V}$



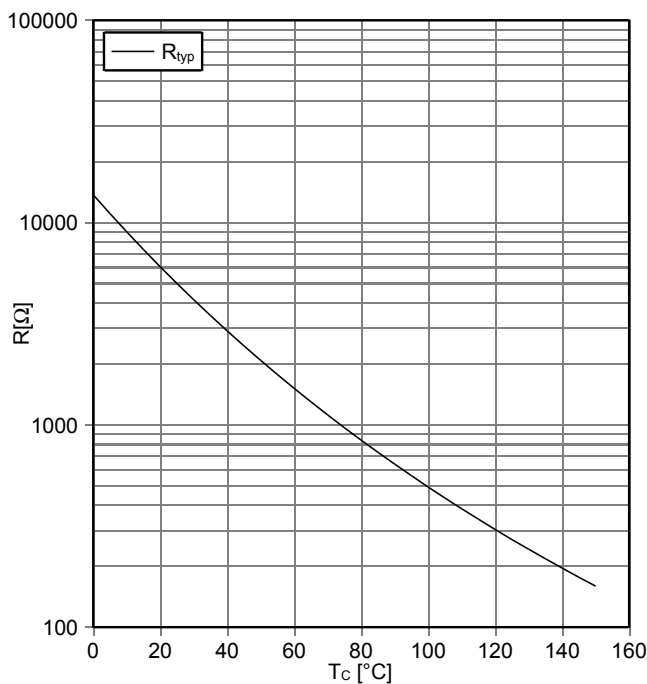
**Transienter Wärmewiderstand Diode, 3-Level  
transient thermal impedance Diode, 3-Level**

$Z_{thJH} = f(t)$



**NTC-Widerstand-Temperaturkennlinie (typisch)  
NTC-Thermistor-temperature characteristic (typical)**

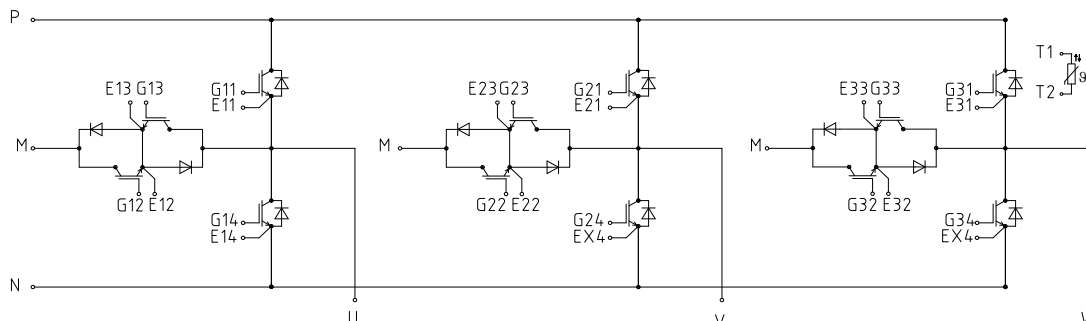
$R = f(T)$



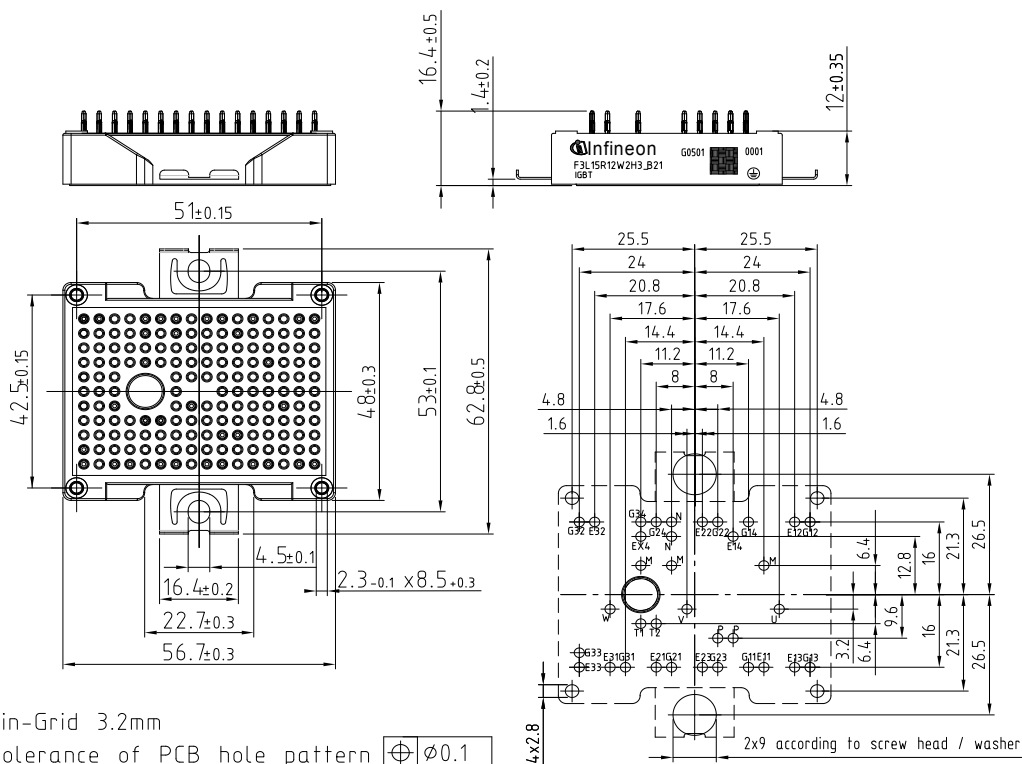
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**Vorläufige Daten**  
**Preliminary Data**

### Schaltplan / circuit\_diagram\_headline



### Gehäuseabmessungen / package outlines



- Pin-Grid 3.2mm
- Tolerance of PCB hole pattern  $\pm \phi 0.1$
- Hole specification for contacts see AN 2009-09
- Diameters of plated holes  $\phi 1.0\text{mm}^{+0.09}_{-0.06}$
- Diameters of drill  $\phi 1.15\text{mm}$

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**Vorläufige Daten  
Preliminary Data**

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- den Abschluss von speziellen Qualitätssicherungsvereinbarungen;
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- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

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